

3A, 400V - 600V High Efficient Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- · Freewheeling application

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.110g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	3	Α	
V_{RRM}	400 - 600	٧	
I _{FSM}	75	Α	
T _{J MAX}	175	°C	
Package	DO-214AA (SMB)		
Configuration	Single die		









DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	MUR340SBH	MUR360SBH	UNIT
Marking code on the device		MUR340SB	MUR360SB	
Repetitive peak reverse voltage	V_{RRM}	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	V
Forward current	I _F	3		Α
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	75		А
Junction temperature	T_J	- 55 to +175		°C
Storage temperature	T _{STG}	- 55 to +175		°C

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R _{eJL}	28	°C/W
Junction-to-ambient thermal resistance	R _{eJA}	52	°C/W
Junction-to-case thermal resistance	R _{eJC}	23	°C/W

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1.5A, T_J = 25^{\circ}C$	V _F	1.00	1.10	V
	$I_F = 3.0A, T_J = 25^{\circ}C$		1.10	1.25	V
	I _F = 1.5A, T _J = 150°C		0.76	1.00	V
	$I_F = 3.0A, T_J = 150$ °C		0.89	1.05	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	I _R	-	10	μΑ
	T _J = 150°C		-	250	μΑ
Junction capacitance	1MHz, V _R = 4.0V	CJ	38	-	pF
Reverse recovery time	$I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$	t _{rr}	-	50	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
MUR3xSBH	DO-214AA (SMB)	3,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 400V(MUR340SBH) to 600V(MUR360SBH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

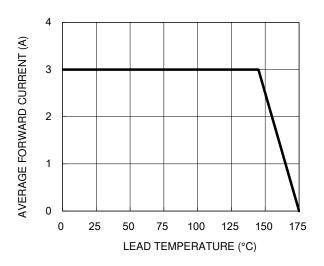


Fig.3 Typical Reverse Characteristics

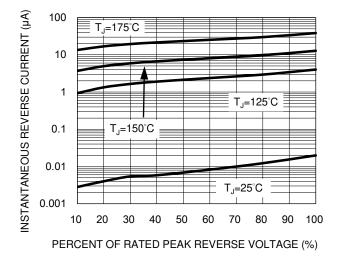


Fig.2 Typical Junction Capacitance

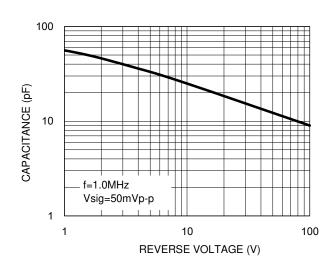
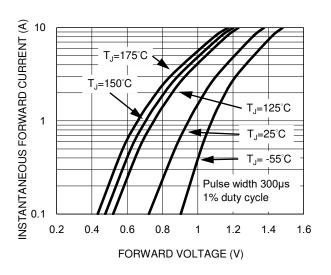


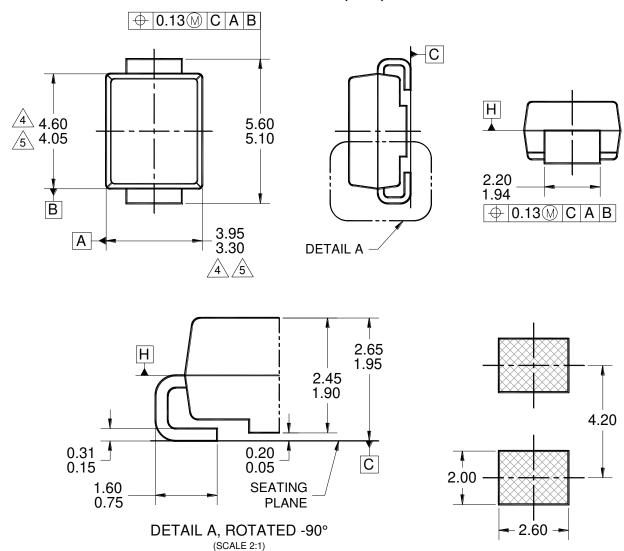
Fig.4 Typical Forward Characteristics

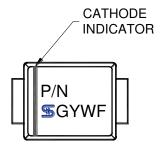


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PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)





MARKING DIAGRAM

P/N = MARKING CODE

G = GREEN COMPOUND

YW = DATE CODE

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.

SUGGESTED PAD LAYOUT

- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AA, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
- 6. DWG NO. REF: HQ2SD07-DO214SMB-035 REV A.



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